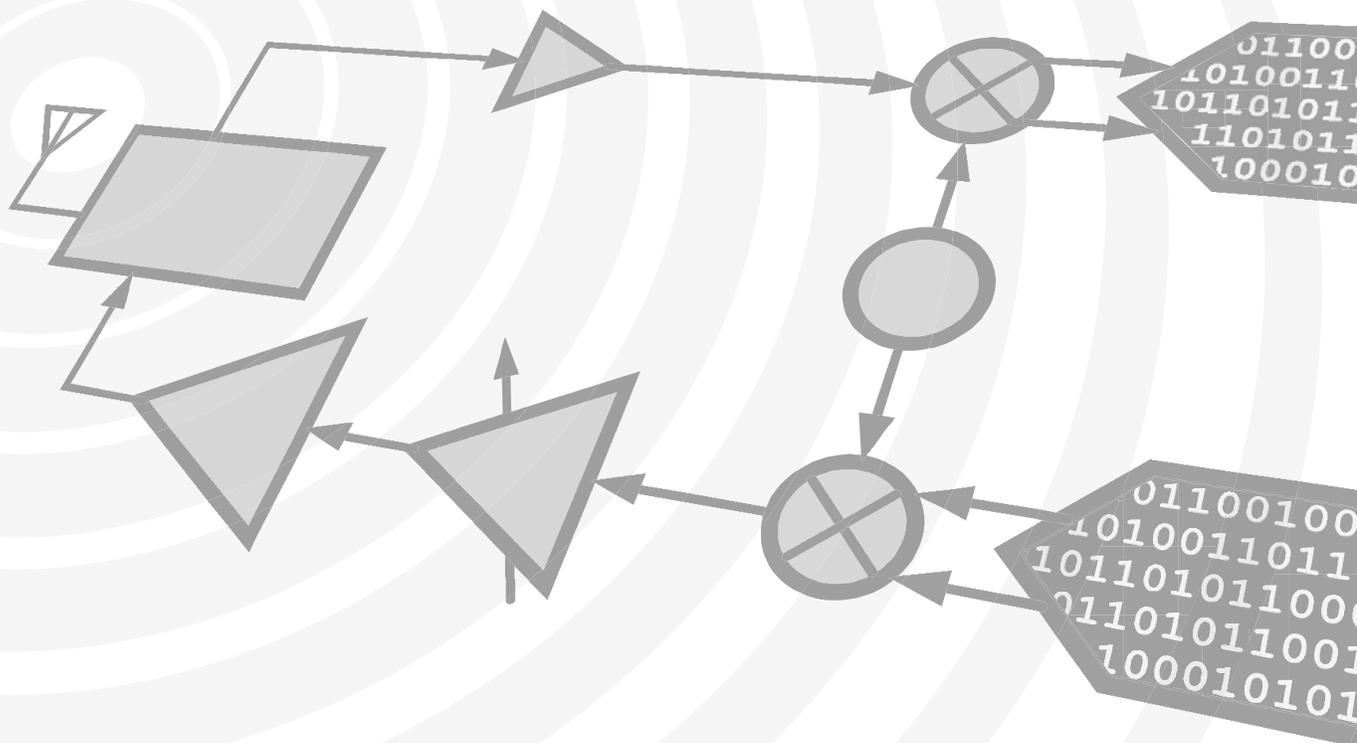


Analog Devices Welcomes Hittite Microwave Corporation

NO CONTENT ON THE ATTACHED DOCUMENT HAS CHANGED



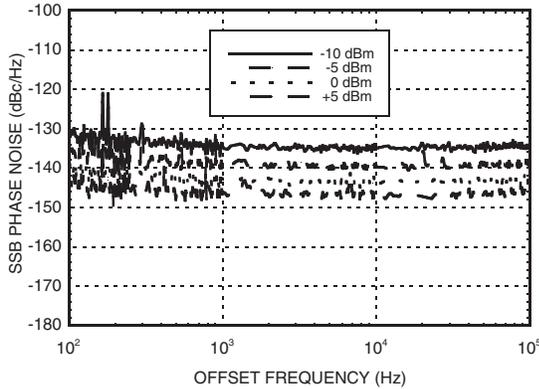
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7 GHz INTEGER N SYNTHESIZER (N = 12 - 259)

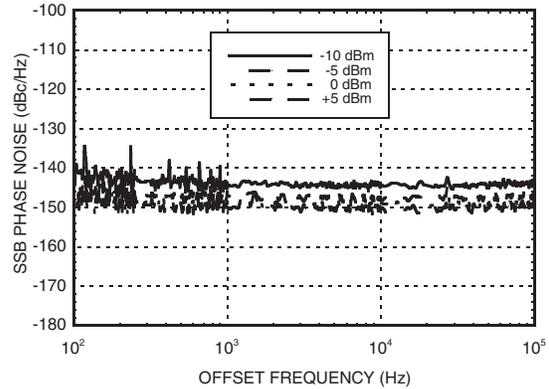
Phase Noise Floor [1][2][3]

Ref = Sine Wave, Vcc = 4.75V



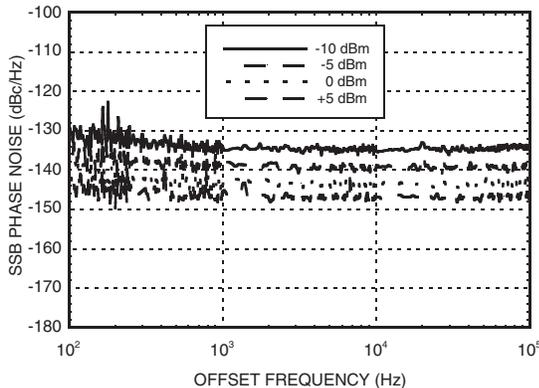
Phase Noise Floor [1][2][3]

Ref = Square Wave, Vcc = 4.75V



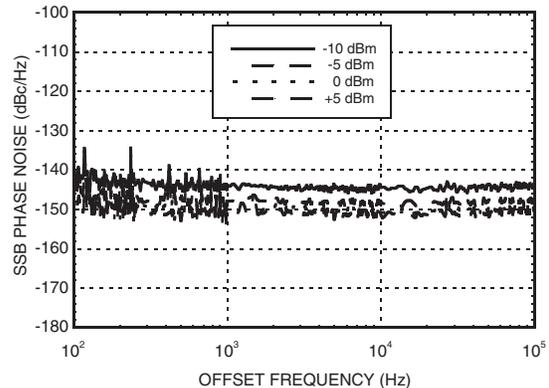
Phase Noise Floor [1][2][3]

Ref = Sine Wave, Vcc = 5V



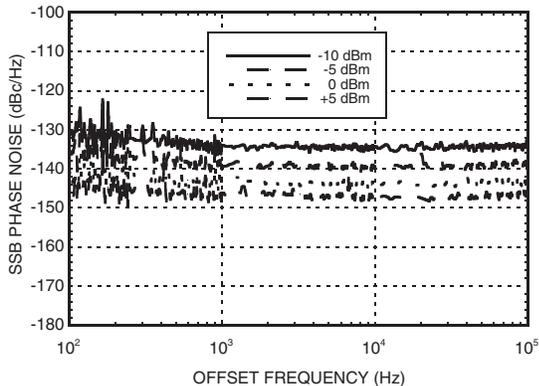
Phase Noise Floor [1][2][3]

Ref = Square Wave, Vcc = 5V



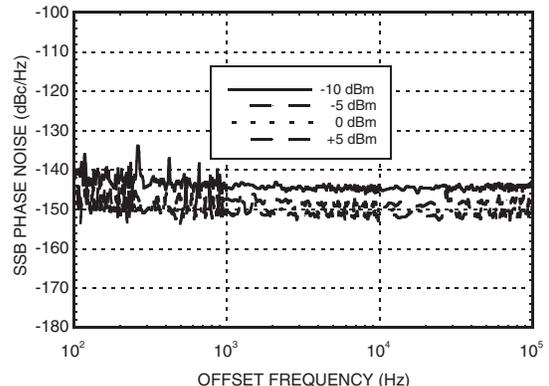
Phase Noise Floor [1][2][3]

Ref = Sine Wave, Vcc = 5.25V



Phase Noise Floor [1][2][3]

Ref = Square Wave, Vcc = 5.25V

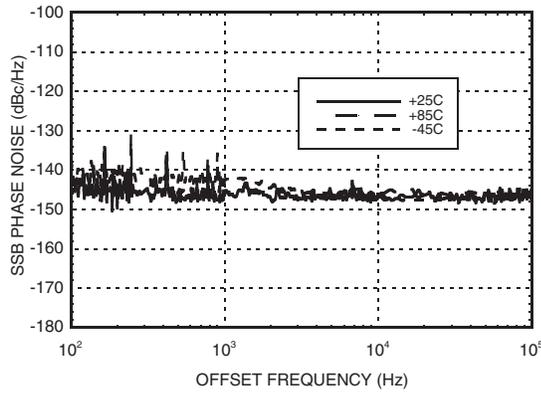


[1] Phase Noise Floor vs Offset Frequency with varying Ref Power Level
 [2] Fin= 7000 MHz @ 0 dBm, Ref Frequency = 100 MHz, N = 70
 [3] Phase Noise Floor remains constant beyond 100 kHz offset frequency



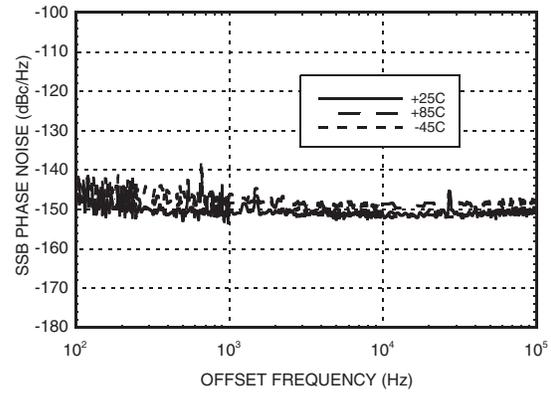
Phase Noise Floor ^{[1][2][3]}

Ref = Sine Wave @ 5 dBm, Vcc = 5V

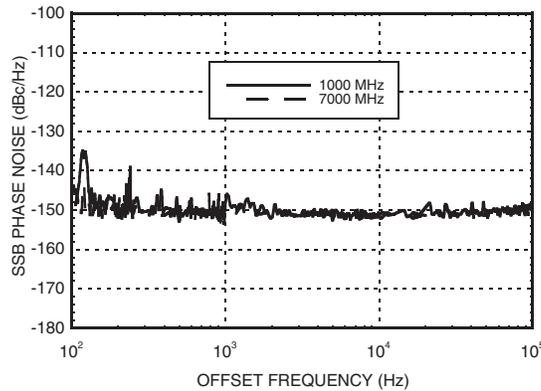


Phase Noise Floor ^{[1][2][3]}

Ref = Square Wave @ 5 dBm, Vcc = 5V



Phase Noise Floor vs Offset Frequency with varying Fin @ 0 dbm, Ref = 100 MHz Square Wave @ 5 dBm, Vcc = 5V ^[3]



[1] Phase Noise Floor vs Offset Frequency over temperature

[2] Fin= 7000 MHz @ 0 dBm, Ref Frequency = 100 MHz, N = 70

[3] Phase Noise Floor remains constant beyond 100 kHz offset frequency



7 GHz INTEGER N SYNTHESIZER (N = 12 - 259)

Absolute Maximum Ratings

RF Input (Vcc= +5V)	+10 dBm
Supply Voltage (Vcc)	+5.5V
Logic Inputs	-0.5V to (0.5V + Vcc)
Junction Temperature (Tc)	135 °C
Continuous P _{diss} (T = 85 °C) (derate 78 mW/° C above 85 °C)	3.9 W
Thermal Resistance (Junction to ground paddle)	12.90 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C

Typical Supply Current vs. Vcc

Vcc (Vdc)	Icc (mA)
4.75	294
5.00	310
5.25	342

Note: HMC698LP5 will work over full voltage range above.

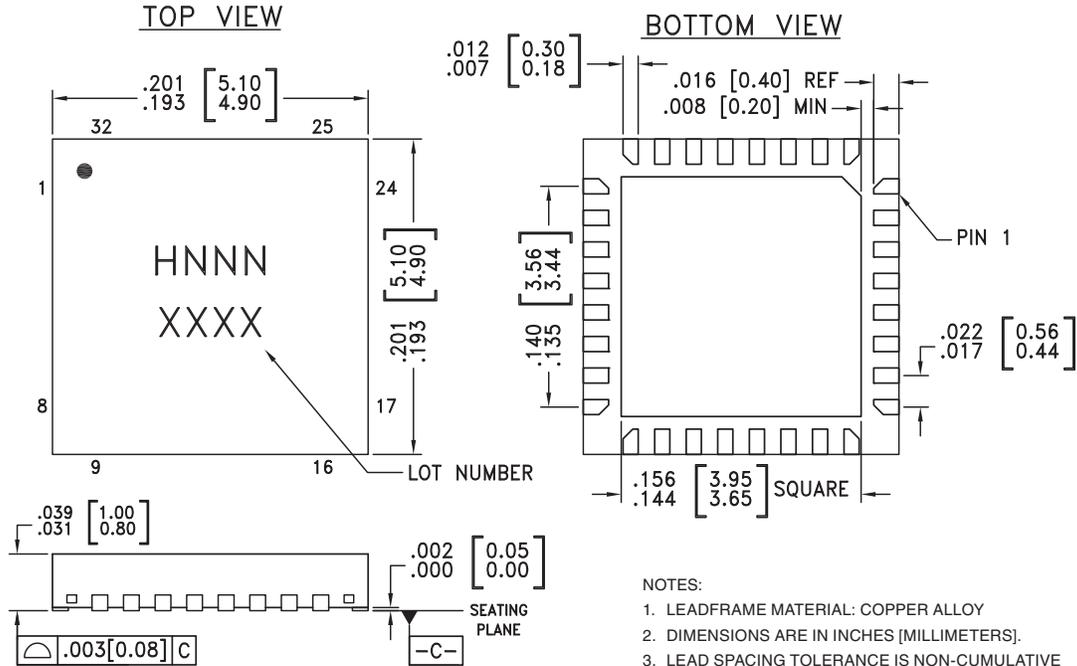


ELECTROSTATIC SENSITIVE DEVICE
OBSERVE HANDLING PRECAUTIONS

Typical DC Characteristics @ Vcc = +5V

Symbol	Characteristics	+25C			Units
		Min.	Typ.	Max.	
Icc	Power Supply Current	280	310	340	mA
Voh	Output High Voltage, (NU, ND)	5	5	5	V
Vol	Output Low Voltage, (NU, ND)	2.9	3.0	3.1	V

Outline Drawing



- NOTES:
1. LEADFRAME MATERIAL: COPPER ALLOY
 2. DIMENSIONS ARE IN INCHES [MILLIMETERS].
 3. LEAD SPACING TOLERANCE IS NON-CUMULATIVE
 4. PAD BURR LENGTH SHALL BE 0.15mm MAXIMUM.
PAD BURR HEIGHT SHALL BE 0.05mm MAXIMUM.
 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED PCB LAND PATTERN.

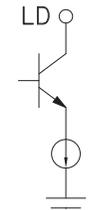
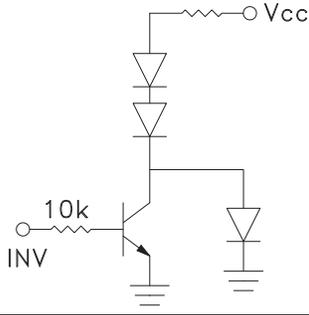
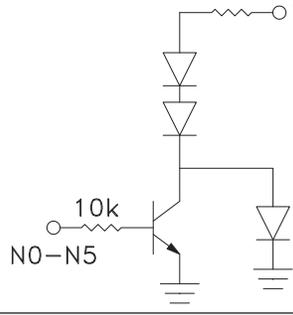
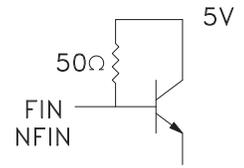
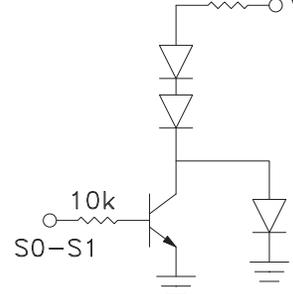
Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC698LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL1 ^[1]	H698 XXXX
HMC698LP5(E)	RoHS-compliant Low Stress Injection Molded Plastic	100% matte Sn	MSL1 ^[2]	H698 XXXX

[1] Max peak reflow temperature of 235 °C
 [2] Max peak reflow temperature of 260 °C
 [3] 4-Digit lot number XXXX



Pin Description

Pin Number	Function	Description	Interface Schematic
1	LD	Pulsed output. Average "LOW" = UNLOCKED. Average "HIGH" = LOCKED	
2	INV	PFD INVERT function CMOS compatible input control bit Logic "LOW" = NORMAL Logic "HIGH" = INVERT	
4, 5, 18, 25	Vcc1, Vcc3, Vcc2, Vcc_pd	Supply Voltage 5V ±0.25V	
9 - 14	N0 - N5	CMOS compatible control input bit 0 (LSB) - 5	
15	FIN	(These pins are AC coupled and must be DC Blocked externally.) Frequency Input	
16	NFIN	Frequency Input Complement	
22, 23	S1, S0	CMOS compatible Control Input bit 0 (LSB) -1	



Pin Description (Continued)

Pin Number	Function	Description	Interface Schematic
28	REF	Reference Input	
27	NREF	Reference Input Complement (These pins are AC coupled and must be DC Blocked externally.)	
30	ND	Down Output	
31	NU	Up Output	
3, 6 - 8, 17, 19 - 21, 24, 26, 29, 32	N/C	No Connection. These pins may be connected to RF/DC ground. Performance will not be affected.	
Ground Paddle	GND	Package bottom has an exposed ground paddle that must be connected to RF/DC ground	



MICROWAVE CORPORATION v03.0709



HMC698LP5 / 698LP5E

7 GHz INTEGER N SYNTHESIZER (N = 12 - 259)

HMC698LP5(E) Programming Truth Table

Division Ratio n	N Counter	N Counter Decimal Set	Swallow S Counter	Swallow S Decimal Set	(LSB) N0	N1	N2	N3	N4	N5	(LSB) S0	S1
12	3	2	0	0	0	1	0	0	0	0	0	0
13	3	2	1	1	0	1	0	0	0	0	1	0
14	3	2	2	2	0	1	0	0	0	0	0	1
15	3	2	3	3	0	1	0	0	0	0	1	1
16	4	3	0	0	1	1	0	0	0	0	0	0
17	4	3	1	1	1	1	0	0	0	0	1	0
18	4	3	2	2	1	1	0	0	0	0	0	1
19	4	3	3	3	1	1	0	0	0	0	1	1
20	5	4	0	0	0	0	1	0	0	0	0	0
21	5	4	1	1	0	0	1	0	0	0	1	0
22	5	4	2	2	0	0	1	0	0	0	0	1
23	5	4	3	3	0	0	1	0	0	0	1	1
⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮	⋮
252	63	62	0	0	0	1	1	1	1	1	0	0
253	63	62	1	1	0	1	1	1	1	1	1	0
254	63	62	2	2	0	1	1	1	1	1	0	1
255	63	62	3	3	0	1	1	1	1	1	1	1
256	64	63	0	0	1	1	1	1	1	1	0	0
257	64	63	1	1	1	1	1	1	1	1	1	0
258	64	63	2	2	1	1	1	1	1	1	0	1
259	64	63	3	3	1	1	1	1	1	1	1	1

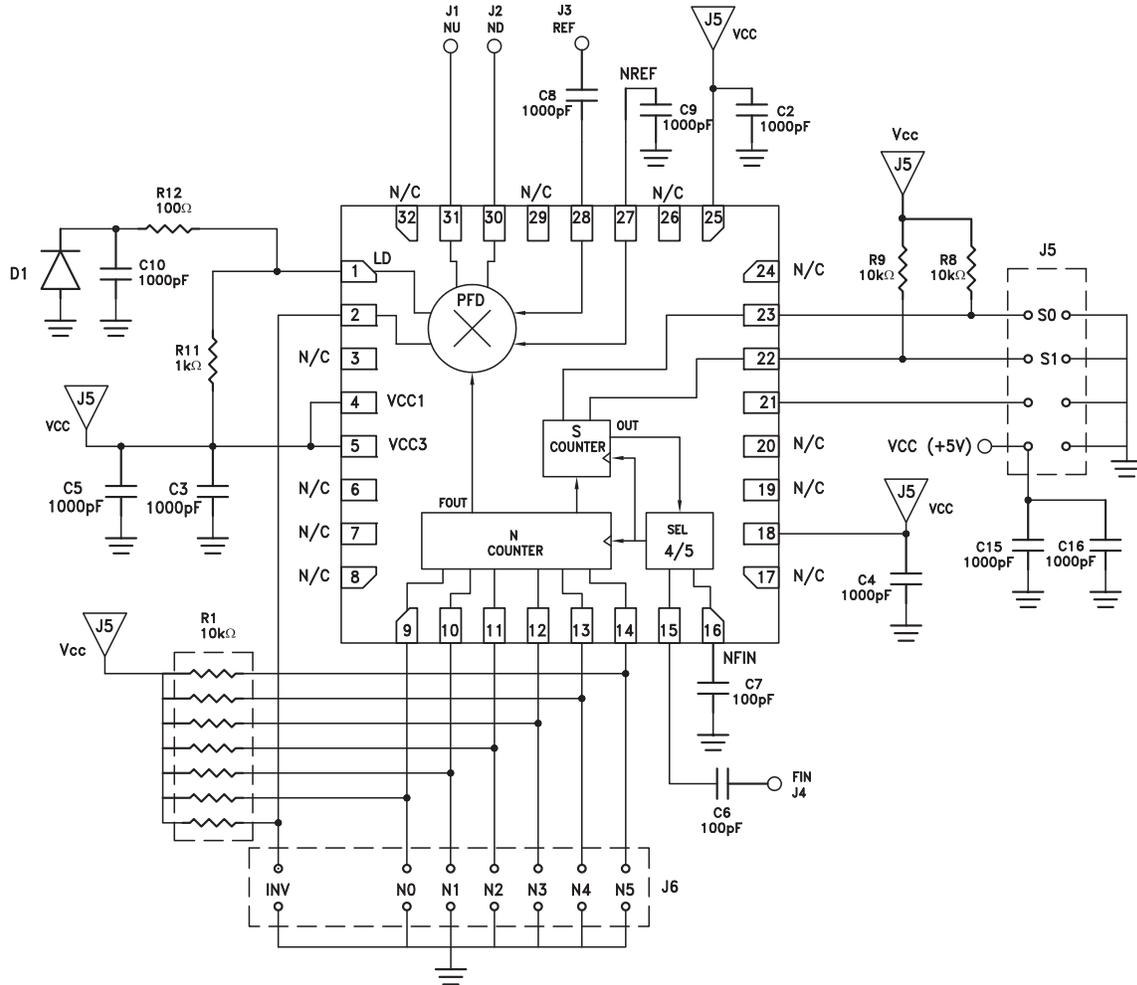
N = INT (n/P)
S = MOD (n/P)
Where: n = Desired division ratio
P = Prescaler value = 4
N = Counter N value (counter decimal set is N - 1)

HMC698LP5(E) Programming Truth Table, Non-Continuous Division Ratios

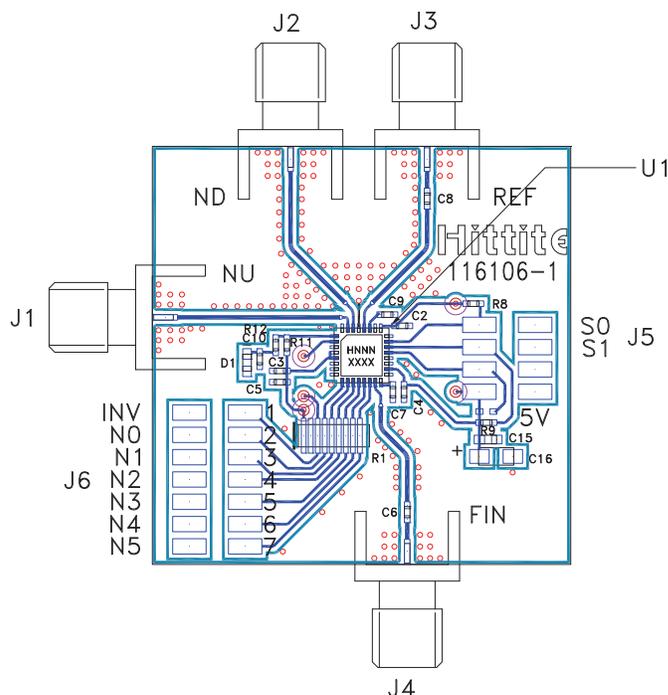
Division Ratio n	N Counter	N Counter Decimal Set	Swallow S Counter	Swallow S Decimal Set	(LSB) N0	N1	N2	N3	N4	N5	(LSB) S0	S1
8	2	1	0	0	1	0	0	0	0	0	0	0
9	2	1	1	1	1	0	0	0	0	0	1	0
10	2	1	2	2	1	0	0	0	0	0	0	1

N = INT (n/P)
S = MOD (n/P)
Where: n = Desired division ratio
P = Prescaler value = 4
N = Counter N value (counter decimal set is N - 1)

Evaluation PCB Circuit



Evaluation PCB



The circuit board used in the final application should use RF circuit design techniques. Signal lines should have 50 ohm impedance while the package backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.

List of Materials for Evaluation PCB 122625 [1]

Item	Description
J1 - J4	PC Mount SMA RF Connector
J5 - J6	2mm DC Header
C1 - C5, C8 - C10	1000 pF Capacitor, 0402 Pkg
C6 - C7	100 pF Capacitor, 0402 Pkg
C15	1000 pF Capacitor, 0603 Pkg
C16	4.7 μ F Tantalum Capacitor Case A
D	LED Green, 0603 Pkg
R1	10k Ohm, Resistor, Array
R8, R9	10k Ohm, Resistor, 0402 Pkg.
R11	1k Ohm, Resistor, 0402 Pkg.
R12	100 Ohm, Resistor, 0402 Pkg.
U1	HMC698LP5(E) Synthesizer
PCB [2]	116106 Eval Board

[1] Reference this number when ordering complete evaluation PCB

[2] Circuit Board Material: Rogers 4350

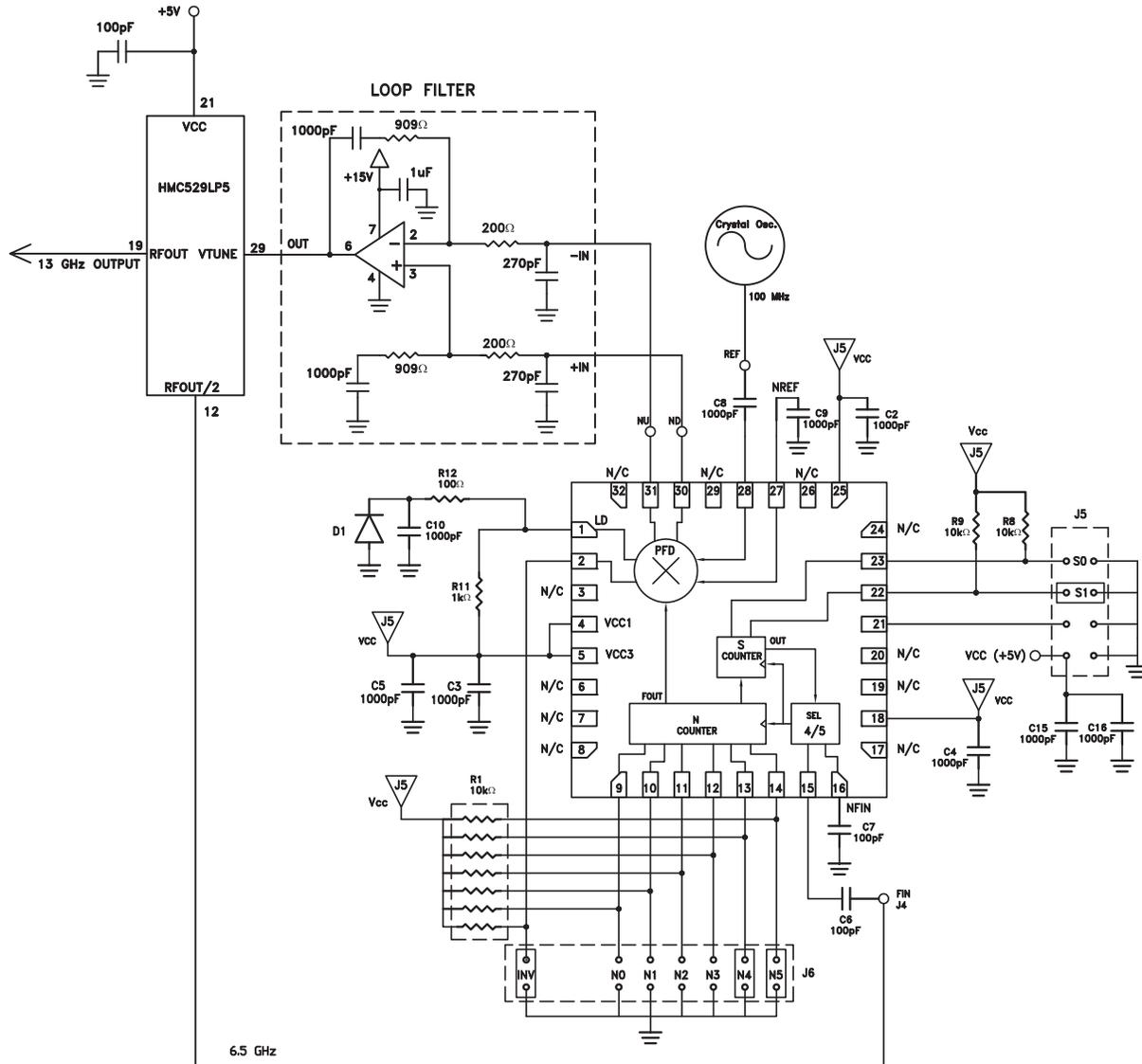
Evaluation PCB Truth Table (see Programming Truth Table)

Note: 0 = Jumper Installed.
1 = Jumper Not Installed.

Note: The evaluation PCB for the HMC698LP5 contains 10K Ohm pull up resistors for each of the 9 control inputs. Programming the 251 distinct division ratios consists of installing or removing jumpers N0 through N5 and S0, S1.

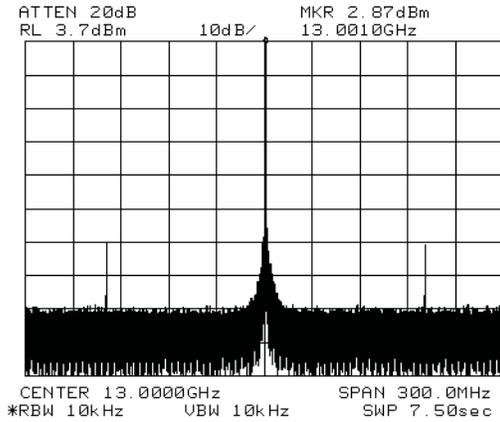
Typical PLL Application Circuit using HMC698LP5

PLL application shown for a 13.0 GHz Fout. Contact HMC to discuss your specific application.

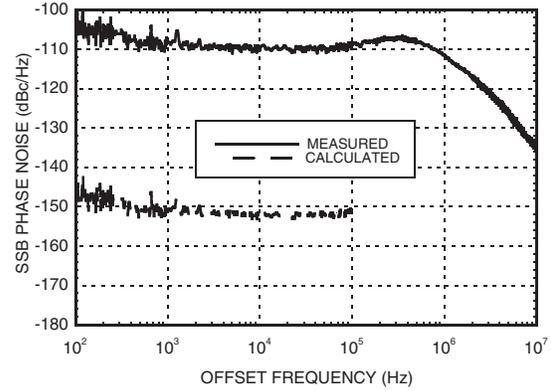




**Typical Application
Showing Spurious Performance**



**Typical Application
13 GHz Measured Phase Noise [1]**



[1] Phase Noise Floor remains constant beyond 100 kHz offset frequency. Measured phase noise using Agilent 5500 with 2 unit measurement technique and corresponding calculated phase noise floor.

CMOS/TTL Input Characteristics

Maximum Input Logic "0" Voltage ($V_{IL\ MAXIMUM}$) = 1.1V @ 1 μ A.

Minimum Input Logic "1" Voltage ($V_{IH\ MINIMUM}$) = 1.8V @ 50 μ A.

Input IV characteristics for the logic inputs (N0 - N5, S0 - S1) are shown below:

